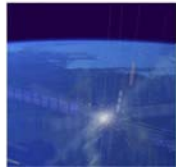


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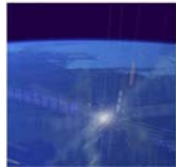
Tuesday, May 4

- 7:00 Registration and continental breakfast
- 8:00 **Welcome and Opening Remarks**
Mel Cohen, The Aerospace Corporation
D. Davis, USAF Space and Missile Systems Center
- 8:10 **Keynote Address**
Dr. S. Matsunaga, The Aerospace Corporation
General Manager, Engineering and Integration Division
- 8:40 **Space and Missile Systems Center Update**
D. Davis, USAF Space and Missile Systems Center
- 9:10 **Defense Supply Center Columbus Update**
J. Gemperline, Chief, Sourcing and Qualification Division, Defense Supply Center, Columbus
- 9:30 **NASA Update**
C. Barnes, NASA/Jet Propulsion Laboratory
- 9:50 **Missile Defense Agency Parts Plan Update**
B. Birdsong, Missile Defense Agency
- 10:10 **Break**
- 10:20 **Radiation-Hardened Space Electronics, High Rev Update**
M. Owens, Air Force Research Laboratories
- 10:40 **National Reconnaissance Office**
Maj. D. Laird, Chief, Product Assurance Branch, National Reconnaissance Office
- 11:00 **U.S. Navy Update**
T. Dowdy, U.S. Navy Trident Program
- 11:20 **European Space Agency Update**
R. de Marino, European Space Agency

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Tuesday, May 4 (continued)

11:40 Japanese Space Exploration Agency Update

T. Mikami, Japan Space Exploration Agency

12:00 Lunch (on your own)

1:00 USAF / SMC PMP Requirements Implementation Panel: Discussions on Technical / Cost Drivers

Facilitator: J. Gartin, Cobham Analytic Solutions

Panel: Prime Contractors and U.S. Government

2:30 Break

2:40 Prohibited Material Analysis Update

T. Hester, Raytheon Corporation

3:00 The Aerospace Corporation's Independent Research in Alternative Pb-Free Solders

D. Witkin, The Aerospace Corporation

3:20 Supplier Update: Texas Instruments Space Products

B. Rhoton, Texas Instruments Corporation

3:40 Supplier Update

J. Castaldo, Aeroflex Plainview

P. Milliken, Aeroflex Colorado Springs

Aeroflex / Metelics

4:10 Supplier Update

K. Karlsen, Microsemi Corporation

4:30 Hermeticity Update

G. Neff, IsoVac Engineering, Inc.

4:50 Discrete Semiconductor Update

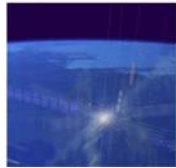
M. Cohen, The Aerospace Corporation

5:10 No-Host Networking Reception

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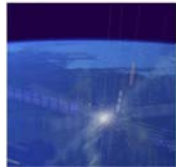
Wednesday, May 5

- 7:00 **Registration and continental breakfast**
- 8:00 **Welcome and Opening Remarks**
D. Davis, USAF Space and Missile Systems Center
- 8:10 **Hi-Rel Laboratories DPA Summary Report**
T. Devaney, Hi-Rel Laboratories
- 8:30 **Microcircuit Update**
D. Peters, The Aerospace Corporation
- 8:50 **Hybrid Update**
J. Sokol, The Aerospace Corporation
- 9:10 **Supplier Update**
M. Tekulve, National Semiconductor Corporation
- 9:30 **Supplier Roadmap**
A. Oullet, ST Microelectronics
- 9:50 **Supplier Update**
G. Panning, Honeywell Corporation
- 10:10 **Break**
- 10:20 **Supplier Update**
K. O'Neill, Actel Corporation
- 10:40 **Supplier Update**
J. Vargas, Semtech Corporation
- 11:00 **Supplier Update**
R. Chesley, Intersil Corporation
- 11:20 **Supplier Update**
R. Albarian, Linear Technology Corporation

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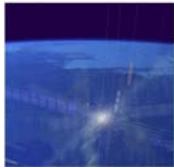
Wednesday, May 5 (continued)

- 11:40 **Supplier Update**
G. Overend, M.S. Kennedy Corporation
- 12:00 **Lunch (on your own)**
- 1:00 **Supplier Update**
E. Reed, Kemet Electronics Corporation
- 1:20 **Supplier Update**
J. Bourne, AVX Tantalum Corporation
- 1:40 **Field Programmable Gate Arrays Update**
L. Harzstark, The Aerospace Corporation
- 2:00 **Supplier Update**
D. Strobel, Space Micro Corporation
- 2:20 **Supplier Update**
K. Karlsen, Microsemi Corporation
- 2:40 **Supplier Update**
D. Sable, VPT Incorporated
- 3:00 **Break**
- 3:10 **Supplier Update**
R. Odile, International Rectifier Corporation
- 3:40 **Supplier Update**
D. Pirkl, BAE Systems Corporation
- 4:00 **Column Grid Arrays**
R. Winslow, Six Sigma
- 4:20 **Supplier Update**
J. Fabula, Xilinx, Inc.

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Wednesday, May 5 (continued)

- 4:40 **Supplier Update**
B. Barfield, Analog Device Incorporated
- 5:00 **Supplier Update**
M. Pitka, Sensitron Semiconductor
- 5:20 **Supplier Update**
B. Caletika, Micropac Industries
- 5:40 **JEDEC Fiber Optic Task Group**
C. Tabbert, Ultra Communications, Inc.
- 6:00 **Supplier Update**
B. Triggs, Semicoa Semiconductor
- 6:20 **Wrap-up and Adjourn**
D. Davis, USAF Space and Missile Systems Center